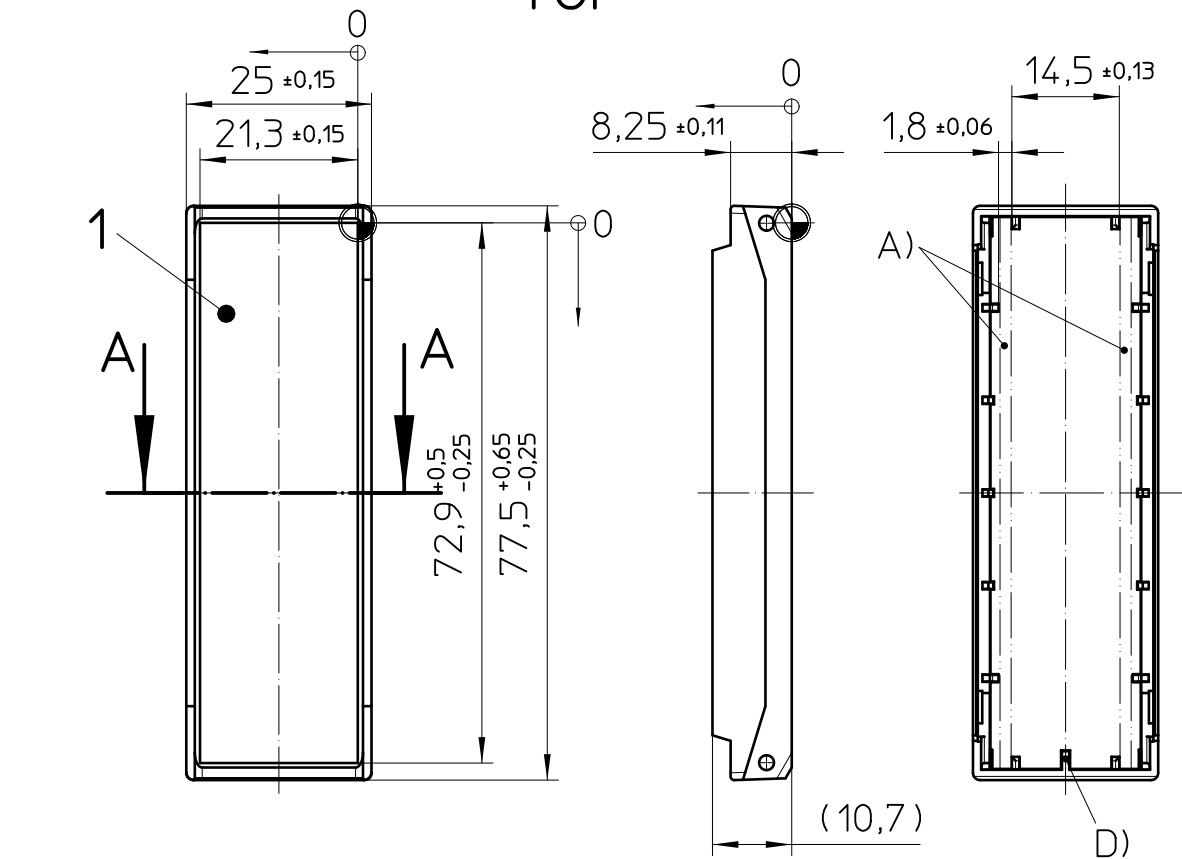


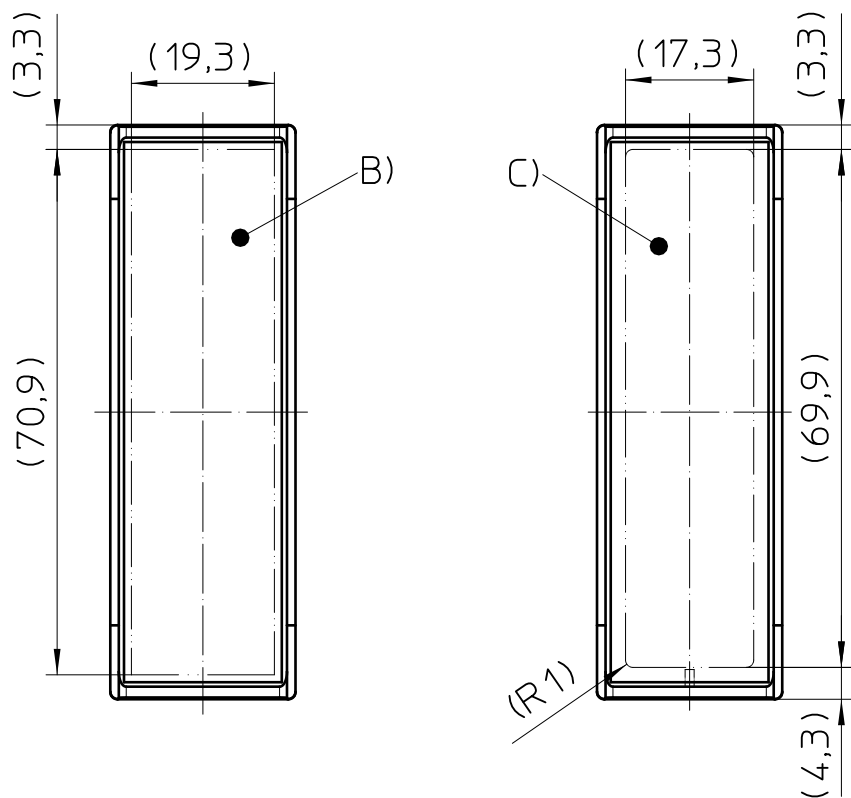
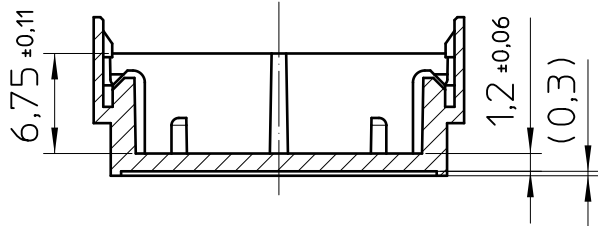
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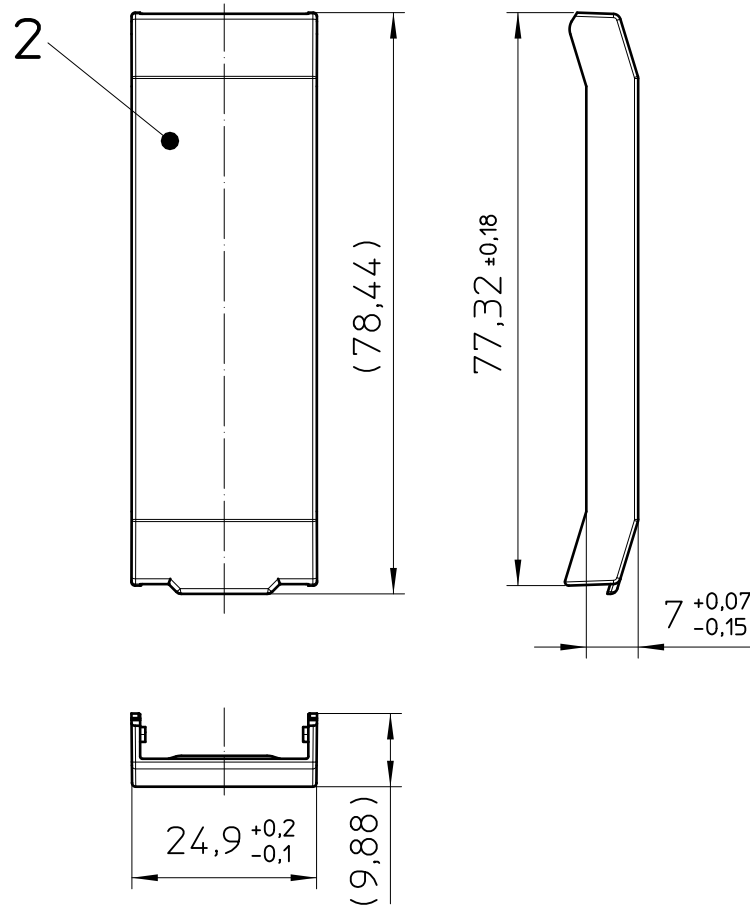
TOP



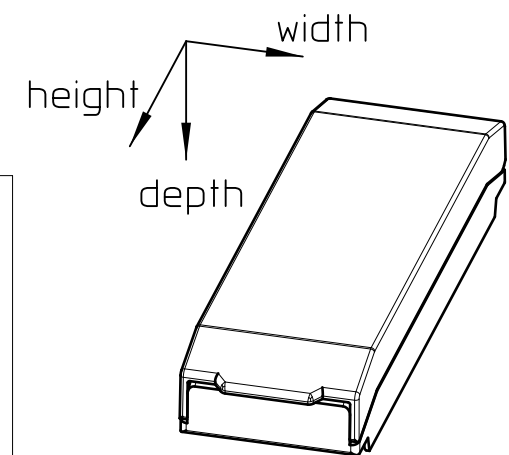
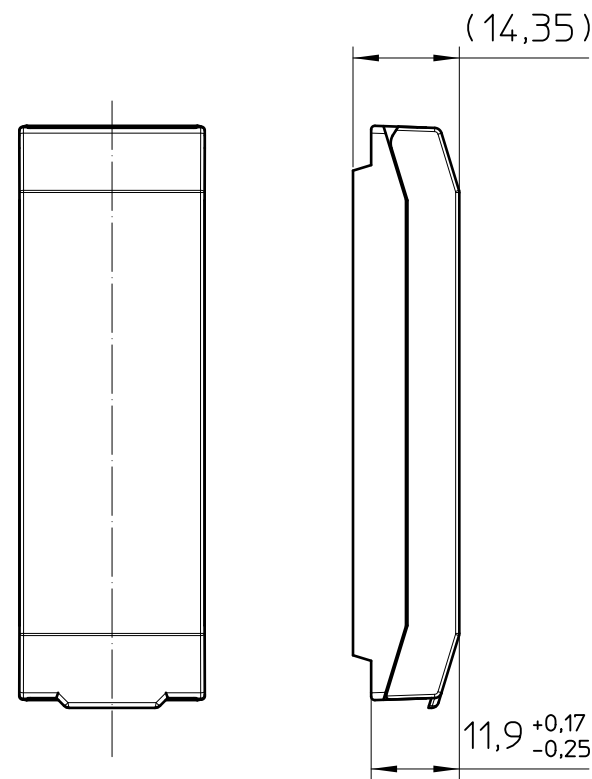
A-A 2:1



HINGED LID



Assembly example



General Information:

- Simplified representation
- Document excluded from change process
- Units are in millimeters [mm] and degrees [°]
- Tolerances apply in a normal climate according to DIN EN ISO 291-23/50-2, PA plastic parts with about 2% (% by weight) moisture content.
- Workpiece zero point for marking and machining processing
- Tolerances for machining processing, milling contour to zero point ±0.2, milling to milling contour ±0.1
- Machining radii min. R1, further on request
- Tolerances for printing DIN ISO 2768-m
- Web: www.phoenixcontact.com webcode: #1635

Additional Information:

- A) PCB t= 1.6±0.2
- B) Max. marking area, 0.3 recessed, only for pad printing, other printing processes on request.
- C) Max. machining area, 0.3 recessed.
- D) Coding

KIT (not mounted)					
Pos.	QTY	Description	Material		
1	1	TOP	PA		
2	1	HINGED LID	PC		
 DIN A3		document-No. / RI 01072087 / 02		date 30.08.2024	scale 1:1
		ident.-No. 1019570		document-type TECDOC 2D_Productdrawing	
		description ICS25-TL77X12-7035			
		page 1		of 1	